To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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NPN SILICON RF TRANSISTOR

Phase-out/Discontinued

2SC5193

NPN EPITAXIAL SILICON RF TRANSISTOR FOR HIGH-FREQUENCY LOW-NOISE AMPLIFICATION 3-PIN SUPER MINIMOLD

FEATURES

- Low Voltage Operation, Low Phase Distortion
- Low Noise
  NF = 1.5 dB TYP. @ V_{CE} = 3 V, I_C = 7 mA, f = 2 GHz
  NF = 1.7 dB TYP. @ V_{CE} = 1 V, I_C = 3 mA, f = 2 GHz
- Large Absolute Maximum Collector Current
  I_C = 100 mA
- 3-pin super minimold Package

★ ORDERING INFORMATION

Part Number	Quantity	Supplying Form
2SC5193	50 pcs (Non reel)	• 8 mm wide embossed taping
2SC5193-T1	3 kpcs/reel	• Pin 3 (collector) face to perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office.
The unit sample quantity is 50 pcs.

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	V_{CBO}	9	V
Collector to Emitter Voltage	V_{CEO}	6	V
Emitter to Base Voltage	V_{EBO}	2	V
Collector Current	I_C	100	mA
Total Power Dissipation	P_{tot} Note	150	mW
Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	–65 to +150	°C

Note Free air

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Date Published August 2004 CP(K)
Printed in Japan

The mark ★ shows major revised points.

ELECTRICAL CHARACTERISTICS (T_A = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	I_{CBO}	V_{CB} = 5 V, I_E = 0 mA	–	–	100	nA
Emitter Cut-off Current	I_{EBO}	V_{EB} = 1 V, I_C = 0 mA	–	–	100	nA
DC Current Gain	h_{FE} Note 1	V_{CE} = 1 V, I_C = 3 mA	80	–	160	–
RF Characteristics						
Gain Bandwidth Product (1)	f_T	V_{CE} = 1 V, I_C = 3 mA, f = 2.0 GHz	4.0	4.5	–	GHz
Gain Bandwidth Product (2)	f_T	V_{CE} = 3 V, I_C = 20 mA, f = 2.0 GHz	–	9.0	–	GHz
Insertion Power Gain (1)	$\lvert S_{21e} \rvert^2$	V_{CE} = 1 V, I_C = 3 mA, f = 2.0 GHz	2.5	3.5	–	dB
Insertion Power Gain (2)	$\lvert S_{21e} \rvert^2$	V_{CE} = 3 V, I_C = 20 mA, f = 2.0 GHz	–	6.5	–	dB
Noise Figure (1)	NF	V_{CE} = 1 V, I_C = 3 mA, f = 2.0 GHz	–	1.7	2.5	dB
Noise Figure (2)	NF	V_{CE} = 3 V, I_C = 7 mA, f = 2.0 GHz	–	1.5	–	dB
Reverse Transfer Capacitance	C_{re} Note 2	V_{CB} = 1 V, I_E = 0 mA, f = 1.0 MHz	–	0.75	0.85	pF

Notes 1. Pulse measurement: PW ≤ 350 μs, Duty Cycle ≤ 2%

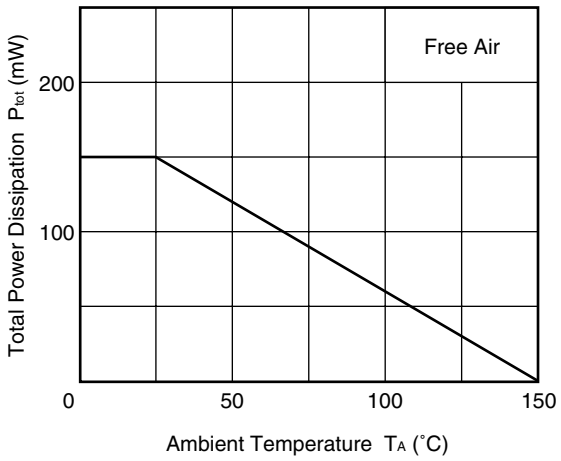
2. Collector to base capacitance when the emitter grounded

h_{FE} CLASSIFICATION

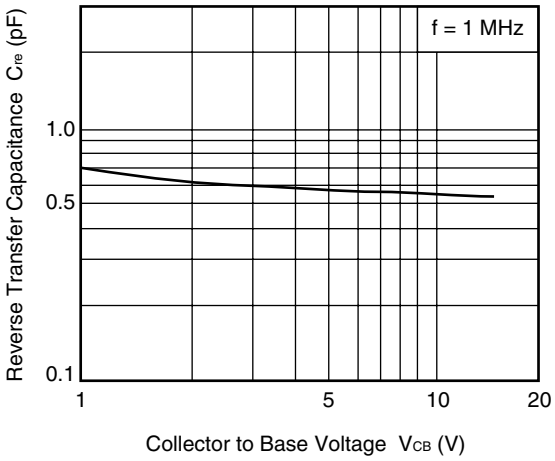
Rank	FB
Marking	T88
h_{FE} Value	80 to 160

TYPICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)

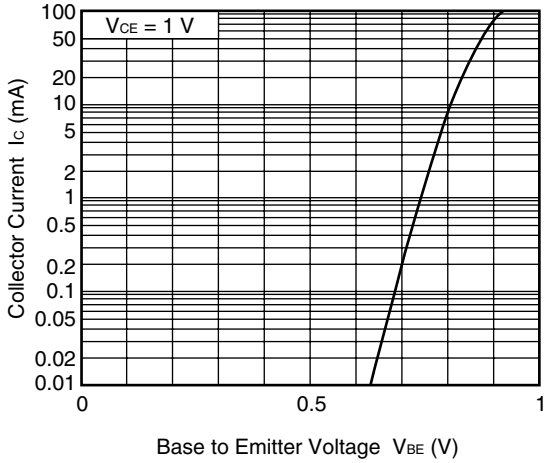
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



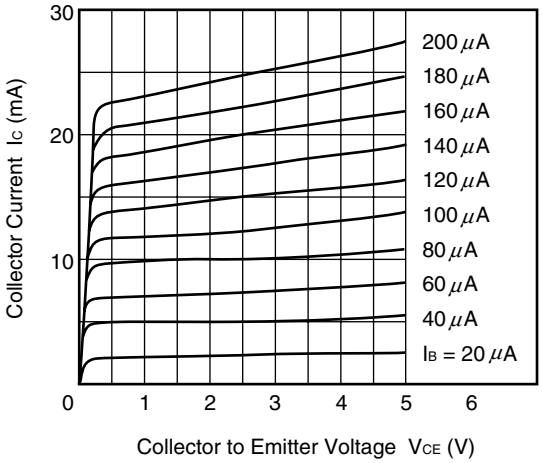
REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE



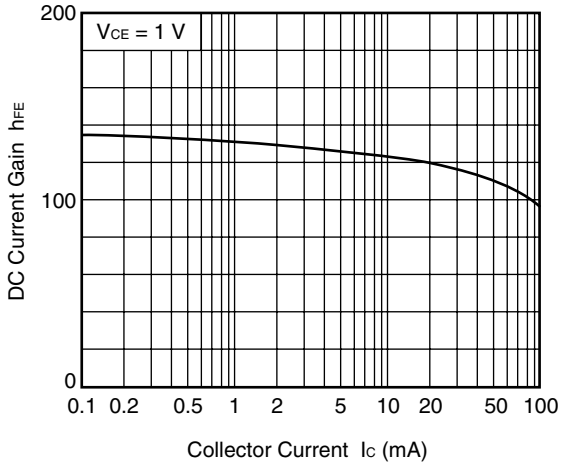
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



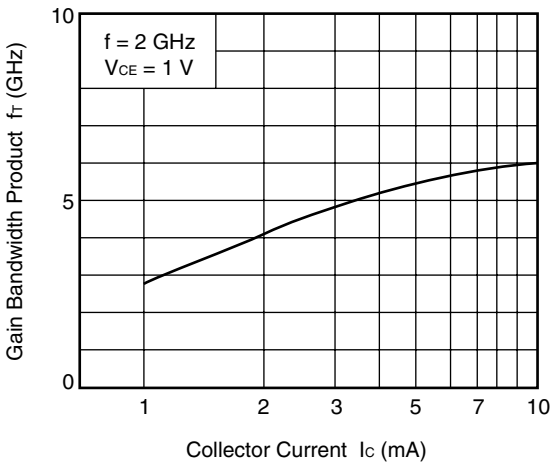
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



DC CURRENT GAIN vs. COLLECTOR CURRENT

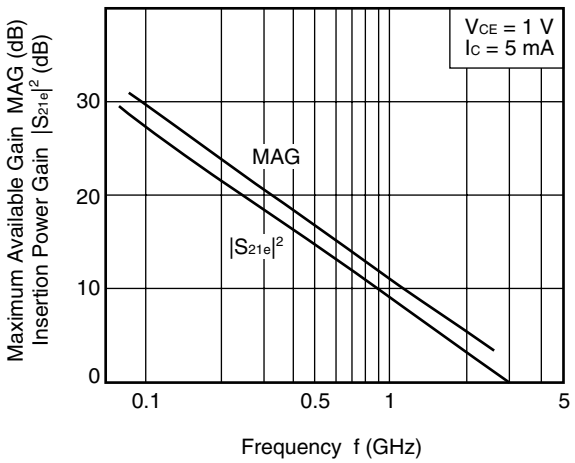


GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT

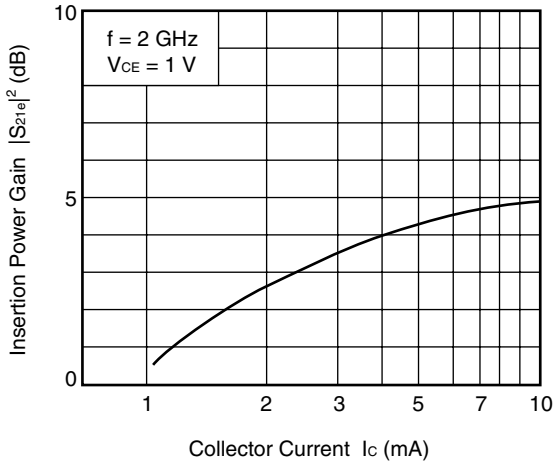


Remark The graphs indicate nominal characteristics.

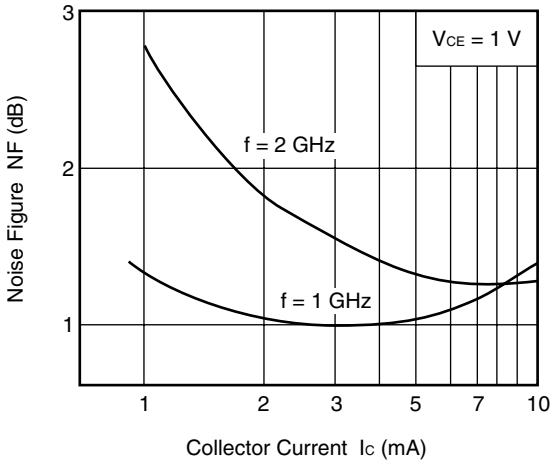
MAXIMUM AVAILABLE GAIN/INSERTION POWER GAIN vs. FREQUENCY



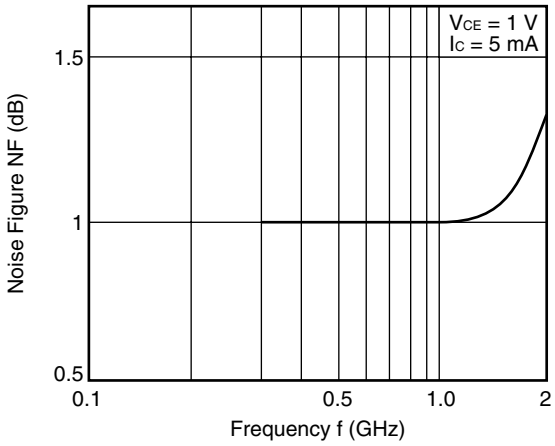
INSERTION POWER GAIN vs. COLLECTOR CURRENT



NOISE FIGURE vs. COLLECTOR CURRENT



NOISE FIGURE vs. FREQUENCY



Remark The graphs indicate nominal characteristics.

★ S-PARAMETERS

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

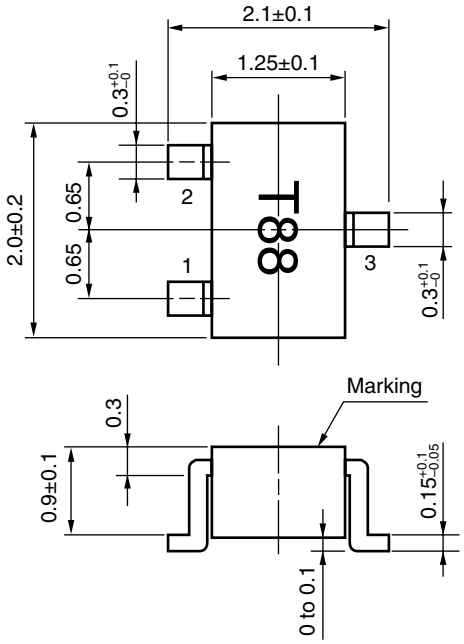
Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

URL http://www.ncsd.necel.com/

★ **PACKAGE DIMENSIONS**

3-PIN SUPER MINIMOLD (UNIT: mm)



PIN CONNECTIONS

1. Emitter
2. Base
3. Collector

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▶For further information, please contact

NEC Compound Semiconductor Devices, Ltd. **http://www.ncsd.necel.com/**
E-mail: salesinfo@ml.ncsd.necel.com (sales and general)
techinfo@ml.ncsd.necel.com (technical)
Sales Division TEL: +81-44-435-1588 FAX: +81-44-435-1579

NEC Compound Semiconductor Devices Hong Kong Limited
E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)
Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH **http://www.ee.nec.de/**
TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. **http://www.cel.com/**
TEL: +1-408-988-3500 FAX: +1-408-988-0279

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